Patented 🗌 Pending Abandoned

DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD AND APPARATUS FOR FORMING ELECTRIC CIRCUIT the specification of which is attached hereto unless the following is checked was filed on January 17, 2002 as United States Application Number 10/047,992 or PCT International Application and was amended on (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred above. I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed. **Priority** Claimed (List prior foreign applications. See 2001-11896 Japan 19 JAN, 2001 🛛 Yes 🗌 No note A below) (Number) (Country) Day/Month/Yea Filed) 2002-3995 Japan 11 JAN, 2002 X Yes No (Number) (Country) (Day/Month/Year Filed) ☐ Yes ☐ No (Country) (Number) (Day/Month/Year Filed) ☐ Yes ☐ No (Country) (Number) (Day/Month/Year Filed) (See note B below) See attached list for additional prior foreign applications I hereby claim the benefit under Title 35, United States Code, ' 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, '112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application. **Status** (List prior U.S. Applications) Patented Pending Abandoned (Application Serial No.) (Filing Date) Patented Pending Abandoned (Application Serial No.) (Filing Date)

on and to transact all business in the

23850

23850

PATENT TRADEMARK OFFICE

Please direct all communications to the following address:

23850

23850

PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, '1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C) Full name of sole or f Inventor's signature	irst inventor (given name, family name)	HITOSHI OHASHI
		Date March 29, 2002
Residence	Shizuoka, Japan	Citizenship Japanese
Post Office Address	c/o Yazaki Corporation, 1500, Mishuku,	Susono-shi, Shizuoka 410-1107, Japan
Inventor's signature Residence	KINYA HORIBE Shizuoka, Japan	KINYA HORIBE Date March 29, 2002 Citizenship Japanese
i ost Office Addiess	c/o Yazaki Corporation, 1500, Mishuku,	Susono-shi, Shizuoka 410-1107, Japan
		HITOSHI USHIJIMA Date March 29, 2002
-	7	Cirihi-
Post Office Address		
	c/o Yazaki Corporation, 1500, Mishuku,	Susono-shi, Shizuoka 410-1107, Japan
Inventor's signature	eventor (given name, family name)	TATSUYA KATO
	Tatsuya Kato	Date March 29, 2002
	Shizuoka, Japan	Citizenship Japanese
Post Office Address	c/o Yazaki Corporation, 1500, Mishuku,	Susono-shi, Shizuoka 410-1107, Japan
Full name of fifth inv Inventor's signature	entor (given name, family name)	Date
Residence		Citizenship
Post Office Address		
	Inventor's signature Residence Post Office Address Full name of second i Inventor's signature Residence Post Office Address Full name of third inv Inventor's signature Residence Post Office Address Full name of fourth ir Inventor's signature Residence Post Office Address Full name of fifth inv Inventor's signature Residence Post Office Address	Residence Post Office Address C/O Yazaki Corporation, 1500, Mishuku, Full name of second inventor (given name, family name) Inventor's signature Residence Shizuoka, Japan Post Office Address C/O Yazaki Corporation, 1500, Mishuku, Full name of third inventor (given name, family name) Inventor's signature Residence Shizuoka, Japan Post Office Address C/O Yazaki Corporation, 1500, Mishuku, Full name of fourth inventor (given name, family name) Inventor's signature Residence Shizuoka, Japan Post Office Address C/O Yazaki Corporation, 1500, Mishuku, Full name of fourth inventor (given name, family name) Inventor's signature Residence Shizuoka, Japan Post Office Address C/O Yazaki Corporation, 1500, Mishuku, Full name of fifth inventor (given name, family name) Inventor's signature Residence

NOTES